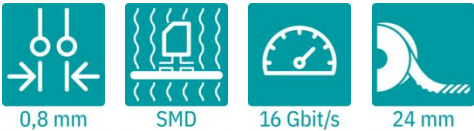


FP 0,8/ 20-MH-SL - SMD male connectors



1575926
<https://www.phoenixcontact.com/us/products/1575926>

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SMD male connector, nominal current: 1.7 A, test voltage: 500 V AC, number of positions: 20, pitch: 0.8 mm, color: black, contact surface: Au, contact connection type: Pin, mounting: SMD soldering

Your advantages

- Compatible PCB footprint enables flexible replacement of the shielded and unshielded version
- Gold-plated contacts ensure transfer quality remains stable over the long term
- Reliable mechanical and electrical connections, thanks to the double-sided ScaleX contact system
- Robustness: ScaleX technology for high tolerance compensation and protection of contacts
- Flexible device design: various numbers of positions, designs, and stack heights with high wipe lengths



Commercial data

Item number	1575926
Packing unit	400 pc
Minimum order quantity	400 pc
Sales key	AA23
Product key	AAWGDI
GTIN	4067923064997
Weight per piece (including packing)	2.35 g
Weight per piece (excluding packing)	0.57 g
Customs tariff number	85366930
Country of origin	CN

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1575926

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Technical data

Product properties

Product type	SMD male connector
Product family	FP 0,8/...-MH-SL
Number of positions	20
Pitch	0.8 mm
Number of rows	2
Pin layout	Linear pad geometry

Electrical properties

Properties

Nominal current I_N	1.7 A IEC 60512-5-2:2002-02 (at 20°C 80-pos.)
Contact resistance	25 mΩ
Test voltage	500 V AC IEC 60512-4-1:2003-05

Data transmission

Data transmission rate	16 Gbps
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Mounting

Mounting type	SMD soldering
Pin layout	Linear pad geometry

Processing notes

Process	Reflow soldering
Moisture Sensitive Level	MSL 1
Classification temperature T_c	260 °C
Solder cycles in the reflow	3

Material specifications

Material data - contact

Note	WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/JEDEC JESD 201
Contact material	Cu alloy
Surface characteristics	Selective coating
Metal surface contact area (top layer)	Gold (min. 0.5 µm Au)
Metal surface contact area (middle layer)	Nickel (1.27 µm - 4 µm Ni)
Metal surface soldering area (top layer)	Tin (2 µm - 6 µm Sn)
Metal surface soldering area (middle layer)	Nickel (1.27 µm - 4 µm Ni)

Material data - housing

Color (Housing)	black (9005)
Insulating material	LCP
Insulating material group	IIIb

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CTI according to IEC 60112	150
Flammability rating according to UL 94	V0

Notes

Notes on operation	The permissible voltage during operation depends on the application, taking into consideration the air clearances and creepage distances within the scope of insulation requirements in accordance with IEC 60664-1.
Details for soldering processes	The items are suitable for assembly on both sides and for overhead soldering.

Dimensions

Dimensional drawing	
Pitch	0.8 mm
Width [w]	12.4 mm
Height [h]	7.05 mm
Length [l]	8.85 mm
Installed height	6.45 mm

Application

Contact cover	0.8 mm
Center offset	± 0.7 mm in longitudinal and transverse direction
Wipe length	1.5 mm
Angular tolerance	± 5 ° in longitudinal and transverse direction (when plugging in) ± 5 ° in longitudinal and transverse direction (when plugged in)
Axial offset in X direction (longitudinal)	± 0.3 mm (Tolerance compensation when plugged in)
Axial offset in Y direction (transversal)	± 0.3 mm (Tolerance compensation when plugged in)

PCB design

Pad geometry	0.5 x 1 mm
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Electrical tests

Thermal test | Test group C

Specification	IEC 60512-5-2:2002-02
Tested number of positions	80

Insulation resistance

Specification	IEC 60512-3-1:2002-02
Insulation resistance, neighboring positions	≥ 5 GΩ

Air clearances and creepage distances |

Insulating material group	IIIb
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1575926

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Minimum value for clearance and creepage distance	0.25 mm
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Environmental and real-life conditions

Durability test

Specification	IEC 60512-9-1:2010-03 (following)
Contact resistance R_1	25 m Ω
Contact resistance R_2	25 m Ω
Insertion/withdrawal cycles	500

Vibration test

Specification	IEC 60068-2-6:2007-12
Frequency	10 - 2000 - 10 Hz
Sweep speed	1 octave/min
Amplitude	1.5 mm (10 Hz ... 58 Hz)
Acceleration	200 m/s ² (58 Hz ... 2000 Hz)
Test duration per axis	2.5 h
Test directions	X-, Y- and Z-axis

Shocks

Specification	IEC 60068-2-27:2008-02
Pulse shape	Semi-sinusoidal
Acceleration	490 m/s ²
Shock duration	11 ms
Test directions	X-, Y- and Z-axis (pos. and neg.)

Railway application: Oscillation/broadband noise

Specification	DIN EN 50155 (VDE 0115-200):2022-06
	IEC 61373:2010-05
Spectrum	Long life test category 2, bogie-mounted
Frequency	$f_1 = 5 \text{ Hz}$ to $f_2 = 250 \text{ Hz}$
ASD level	6.12 (m/s ²) ² /Hz
Acceleration	30.6 m/s ²
Test duration per axis	5 h
Test directions	X-, Y- and Z-axis
Contact interruption	< 1 μ s
Result	Test passed

Railway application: Shocks

Specification	DIN EN 50155 (VDE 0115-200):2022-06
	IEC 61373:2010-05
Pulse shape	Semi-sinusoidal
Acceleration	490 m/s ²
Shock duration	11 ms
Number of shocks per direction	3
Test directions	X-, Y- and Z-axis (pos. and neg.)

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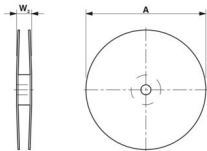
<https://www.phoenixcontact.com/us/products/1575926>

Contact interruption	< 1 μ s
Result	Test passed

Ambient conditions

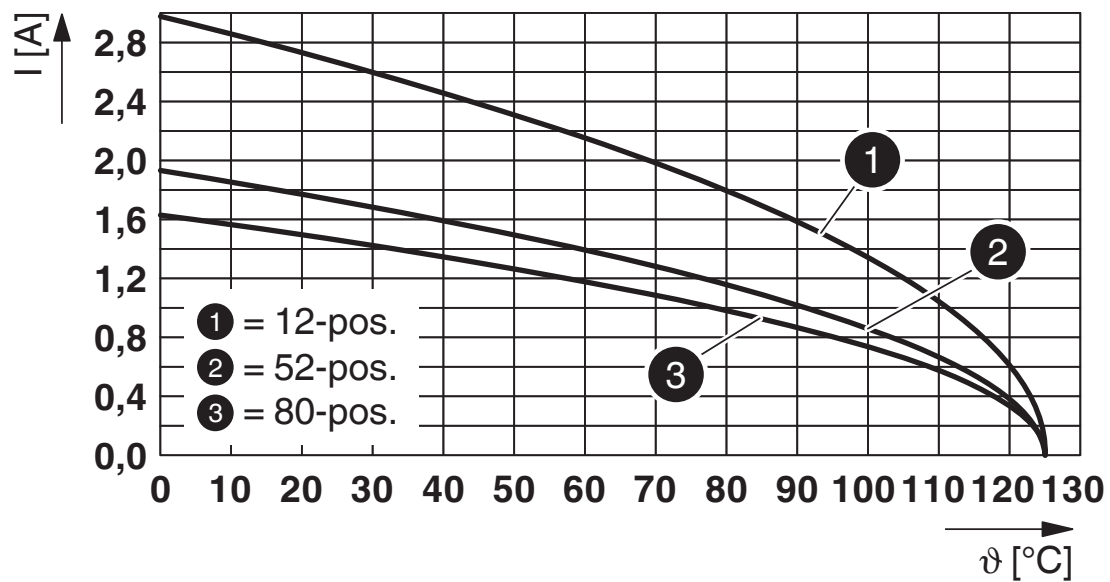
Ambient temperature (storage/transport)	-40 °C ... 70 °C
Relative humidity (storage/transport)	30 % ... 70 %
Ambient temperature (assembly)	-5 °C ... 100 °C
Ambient temperature (operation)	-55 °C ... 125 °C

Packaging specifications

Dimensional drawing	
Type of packaging	24 mm wide tape
[W] tape width	24 mm
[W2] coil overall dimension	≤ 30.4 mm
[A] coil diameter	≤ 330 mm
Outer packaging type	Transparent-Bag

Drawings

Diagram



Type: FP 0,8/...-MH-SL with FP 0,8/...-FH

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Approvals

To download certificates, visit the product detail page: <https://www.phoenixcontact.com/us/products/1575926>



cULus Recognized

Approval ID: E118976-20190703

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Classifications

ECLASS

ECLASS-13.0	27460201
ECLASS-15.0	27460201

ETIM

ETIM 10.0	EC002637
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Environmental product compliance

EU RoHS

Fulfills EU RoHS substance requirements	Yes, No exemptions
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China RoHS

Environment friendly use period (EFUP)	EFUP-E
	No hazardous substances above the limits

EU REACH SVHC

REACH candidate substance (CAS No.)	No substance above 0.1 wt%
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